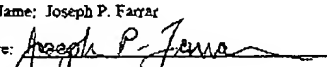


**RECEIVED  
CENTRAL FAX CENTER****MAR 19 2007****IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant(s): NABESHIMA et al.	Atty. Docket: PA214WP002
Serial No.: 10/598,933	Group Art Unit: n/a
Filed: 14 September 2006	Examiner: n/a
Title: SEMICONDUCTOR WAFER INSPECTION DEVICE AND METHOD	

Date: March 19, 2007

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450  
Mail Stop: Petition

<b>CERTIFICATE OF FACSIMILE TRANSMISSION</b>
I hereby certify that this correspondence is being facsimile transmitted to the United States Patent and Trademark Office, Office of Petitions, Fax No. 571-273-8300, on March 19, 2007.
Typed Name: Joseph P. Farrar
Signature: 

**PETITION UNDER 37 CFR 1.78(a)(3)**  
**TO ACCEPT UNINTENTIONALLY DELAYED PRIORITY CLAIM**

Sir:

Applicant hereby petitions pursuant to 37 C.F.R. 1.78(a)(3) to claim the benefit of priority for the above-identified application, under 35 USC 120 and 365(c), of prior-filed international application PCT JP05/07120, filed on April 13, 2005.

In particular, pursuant to 37 CFR 1.78(a)(2) and (a)(3)(i) and 35 USC 120, a 4-page UPDATED application data sheet with appropriate priority information and a preliminary amendment inserting the appropriate priority information into the application are attached.

It should be noted that the original application data sheet filed with the present application listed both Japanese priority patent application no. 2005-152672 and PCT application

Application No.: 10/598,933

Atty. Docket No.: PA214WP002

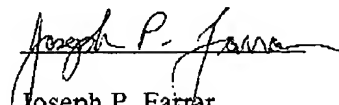
PCT/JP05/07120 under the heading "Foreign Priority Information." The updated application data sheet respectively lists Japanese priority patent application no. 2005-152672 under the heading "Foreign Priority Information" and PCT application PCT/JP05/07120 under the heading "Domestic Priority Information." Therefore, the present application should be treated as a continuation of the aforementioned PCT application under 37 C.F.R. 1.53(b).

Pursuant to 37 C.F.R. 1.78(a)(3)(ii), authorization is hereby provided to debit Deposit Account 50-3546 for the required petition fee as set forth in 37 C.F.R. 1.17(t). Any additional necessary fees may also be charged to Deposit Account 50-3546.

Pursuant to 37 C.F.R. 1.78(a)(3)(iii), and for the reasons set forth above, the undersigned states that the entire delay between the priority claim due date as defined under 37 CFR 1.78(a)(3)(ii) and the present claim for priority was unintentional.

It is respectfully requested that the above petition be timely granted and that the above claims for priority be entered into the record.

Respectfully submitted,



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Attachments: (1) UPDATED Application Data Sheet (4 pages)  
(2) Preliminary Amendment (3 pages)

MAR 19 2007

Application Data Sheet

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Attorney Docket No: PA214WP002

Komatsu Electronic

Serial No.: 10/598,933

Applicant: NABESHIMA et al.UPDATED Application Data SheetApplication Information

Application Type:: Regular/~~U.S. National Stage under 35 USC 371~~  
Subject Matter:: Utility  
Suggested Classification:: n/a  
Suggested Group Art Unit:: n/a  
CD-ROM or CD-R? None  
Title:: Semiconductor wafer inspection device and  
method  
Request for Early Publication?:: No  
Request for Non-Publication?:: No  
Suggested Drawing Figure:: None  
Total Drawing Sheets:: 6  
Small Entity:: No  
Petition included?:: No  
Secrecy Order in Parent Appl.?:: No

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Postal or Zip Code of mailing address:: 254-0014

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## Application Data Sheet

Page 2 of 4

Attorney Docket No: PA214WP002

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## Application Data Sheet

Page 3 of 4

Attorney Docket No: PA214WP002

Komatsu Electronic

Serial No.: 10/598,933Applicant: NABESHIMA et al.

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## Application Data Sheet

Page 4 of 4

Attorney Docket No: PA214WP002

Komatsu Electronic

Serial No.: 10/598,933Applicant: NABESHIMA et al.

Representative Registration Number:: 54,596

Foreign Priority Information

Country:: Application Number:: Filing Date:: Priority Claimed::

International PCT/JP05/07120 04/13/05

Japan 2005-152672 04/13/04 Yes

Domestic Priority InformationContinuity Type Application Number:: Filing Date:: Priority Claimed::Continuation of PCT/JP05/07120 04/13/05 Yes

International Publication No.: WO 2005/101483 A1

International Publication Date:: 10/27/2005